

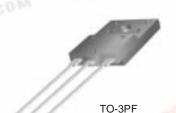
## FFAF15U120DN

### **Features**

- High voltage and high reliability
- High speed switching
- Low forward voltage

### **Applications**

- General purpose
- Switching mode power supply
- Free-wheeling diode for motor application
- · Power switching circuits





1. Anode 2. Cathode 3. Anode

## **ULTRA FAST RECOVERY POWER RECTIFIER**

## Absolute Maximum Ratings (per diode) T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	1200	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 100°C	15	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	90	А
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and StorageTemperature	- 65 to +150	°C

## **Thermal Characteristics**

Symbol	Parameter	Value	Units	
Reac	Maximum Thermal Resistance, Junction to Case	1.0	°C/W	

### Electrical Characteristics (per diode) T<sub>C</sub>=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>FM</sub> *	Maximum Instantaneous Forward Voltage  I <sub>F</sub> = 15A  I <sub>F</sub> = 15A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	3	- v	3.5 3.2	V
RM *	Maximum Instantaneous Reverse Current @ rated V <sub>R</sub>	$T_C = 25 °C$ $T_C = 100 °C$	-	-	15 1	μA mA
n Qn	Maximum Reverse Recovery Time Maximum Reverse Recovery Current Maximum Reverse Recovery Charge (I <sub>F</sub> =15A, di/dt = 200A/μs)		- - -	- - -	100 9 405	ns A nC
W <sub>AVL</sub>	Avalanche Energy		1.0	-	-	mJ

<sup>\*</sup> Pulse Test: Pulse Width=300μs, Duty Cycle=2%

# **Typical Characteristics**

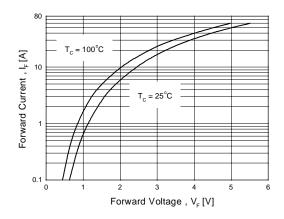


Figure 1. Typical Forward Voltage Drop vs. Forward Current

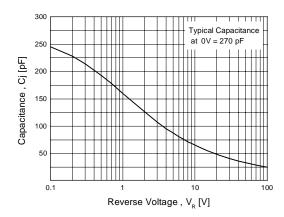


Figure 3. Typical Junction Capacitance

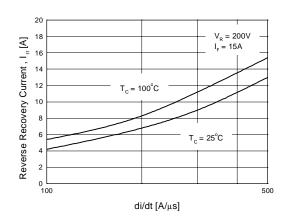


Figure 5. Typical Reverse Recovery Current vs. di/dt

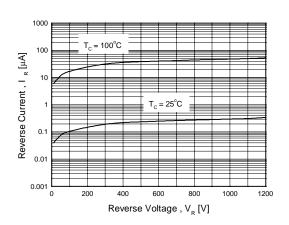


Figure 2. Typical Reverse Current vs. Reverse Voltage

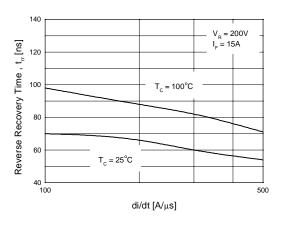


Figure 4. Typical Reverse Recovery Time vs. di/dt

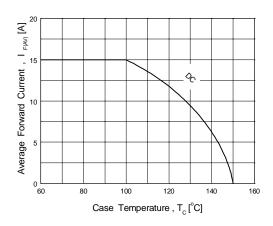
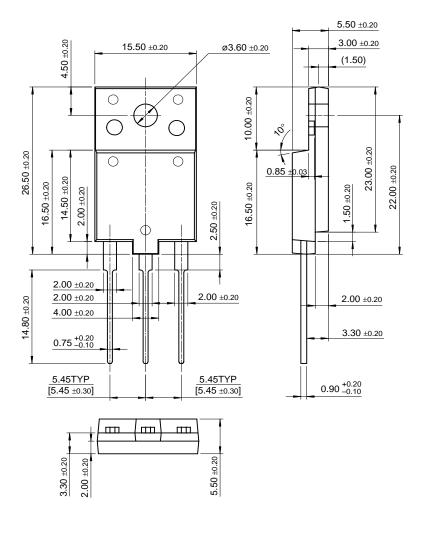


Figure 6. Forward Current Derating Curve

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# **Package Dimensions**

# TO-3PF



Dimensions in Millimeters

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